

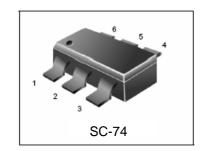
# **General Purpose Transistors**NPN Silicon

- We declare that the material of product compliance with RoHS requirements.
- S- Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q101 Qualified and PPAP Capable.

#### **ORDERING INFORMATION**

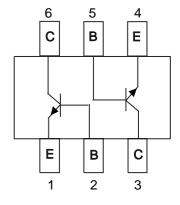
Device	Marking	Shipping
L2SC2412KQMT1G S-L2SC2412KQMT1G	BQ	3000 Tape & Reel
L2SC2412KQMT3G S-L2SC2412KQMT3G	BQ	10000 Tape & Reel
L2SC2412KRMT1G S-L2SC2412KRMT1G	BR	3000 Tape & Reel
L2SC2412KRMT3G S-L2SC2412KRMT3G	BR	10000 Tape & Reel
L2SC2412KSMT1G S-L2SC2412KSMT1G	G1F	3000 Tape & Reel
L2SC2412KSMT3G S-L2SC2412KSMT3G	G1F	10000 Tape & Reel

## L2SC2412KQMT1G Series S-L2SC2412KQMT1G Series



#### **MAXIMUM RATINGS**

Rating	Symbol	Value	Unit
Collector–Emitter Voltage	$V_{\text{CEO}}$	50	V
Collector–Base Voltage	V <sub>CBO</sub>	60	V
Emitter-Base Voltage	$V_{EBO}$	7.0	V
Collector Current — Continuous	I <sub>c</sub>	150	mAdc
Collector power dissipation	P <sub>c</sub>	0.2	W
Junction temperature	T j	150	°C
Storage temperature	T <sub>stg</sub>	-55 <b>~</b> +150	°C



#### **DEVICE MARKING**

L2SC2412KQMT1G =BQ L2SC2412KRMT1G =BR L2SC2412KSMT1G =G1F

#### **ELECTRICAL CHARACTERISTICS** (T<sub>A</sub> = 25°C unless otherwise noted.)

Characteristic	Symbol	Min	Тур	Max	Unit
Collector–Emitter Breakdown Voltage	V <sub>(BR)CEO</sub>	50	_		V
$(I_C = 1 \text{ mA})$	(BR)OEO				
Emitter–Base Breakdown Voltage	V <sub>(BR)EBO</sub>	7	_	_	V
$(I_E = 50 \mu\text{A})$	(511)250				
Collector–Base Breakdown Voltage	V <sub>(BR)CBO</sub>	60	_	_	V
$(I_C = 50 \mu\text{A})$	(BR)OBO				
Collector Cutoff Current	I <sub>CBO</sub>	_	_	0.1	μА
$(V_{CB} = 60 \text{ V})$					r-
Emitter cutoff current	I <sub>EBO</sub>	_	_	0.1	μΑ
(V <sub>EB</sub> = 7 V)					r-
Collector-emitter saturation voltage	V <sub>CE(sat)</sub>	_	_	0.4	V
$(I_{C}/I_{B} = 50 \text{ mA} / 5 \text{m A})$	OE(3at)			_	
DC current transfer ratio	h <sub>FE</sub>	120	_	560	_
$(V_{CE} = 6 V, I_{C} = 1 mA)$					
Transition frequency	f <sub>T</sub>		180		MHz
$(V_{CE} = 12 \text{ V}, I_{E} = -2\text{mA}, f = 30\text{MHz})$	•				
Output capacitance	C <sub>ob</sub>		2.0	3.5	pF
$(V_{CB} = 12 \text{ V}, I_{E} = 0\text{A}, f = 1\text{MHz})$	- 00				•

#### h FE values are classified as follows:



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Fig.1 Grounded emitter propagation characteristics

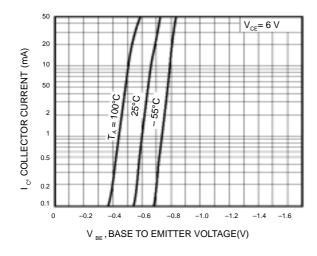


Fig.2 Grounded emitter output characteristics(])

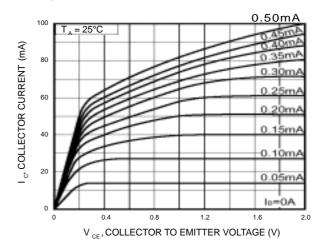


Fig.3 Grounded emitter output characteristics( I)

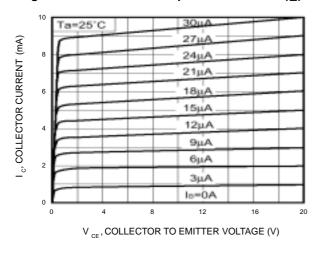


Fig.4 DC current gain vs. collector current (I)

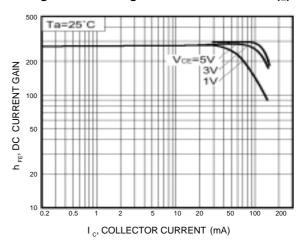


Fig.5 DC current gain vs. collector current (I)

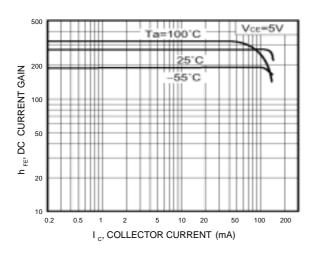
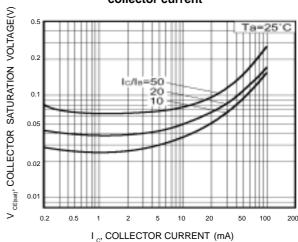


Fig.6 Collector-emitter saturation voltage vs. collector current





### L2SC2412KQMT1G S-L2SC2412KQMT1G Series Series

Fig.7 Collector-emitter saturation voltage vs. collector current ([)

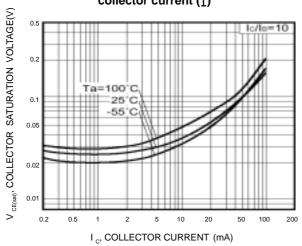


Fig.8 Collector-emitter saturation voltage vs. collector current (I)

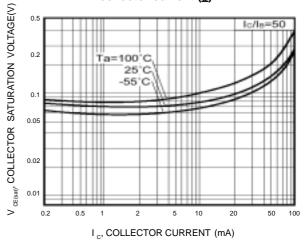


Fig.9 Gain bandwidth product vs. emitter current

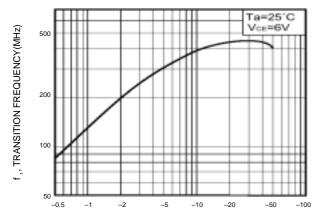


Fig.10 Collector output capacitance vs.collector-base voltage Emitter inputcapacitance vs. emitter-base voltage

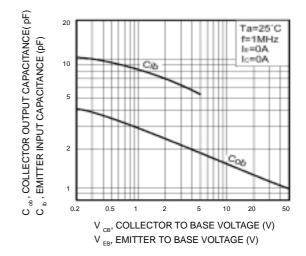
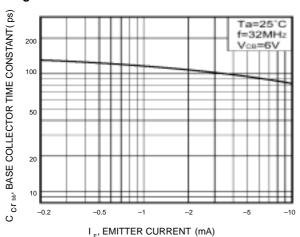


Fig.11 Base-collector time constant vs.emitter current

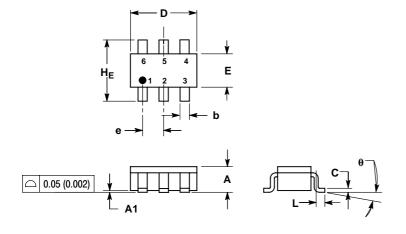
I F, EMITTER CURRENT (mA)





# L2SC2412KQMT1G S-L2SC2412KQMT1G Series Series

# SC-74



	MILLIMETERS			INCHES			
DIM	MIN	NOM	MAX	MIN	NOM	MAX	
Α	0.90	1.00	1.10	0.035	0.039	0.043	
A1	0.01	0.06	0.10	0.001	0.002	0.004	
b	0.25	0.37	0.50	0.010	0.015	0.020	
С	0.10	0.18	0.26	0.004	0.007	0.010	
D	2.90	3.00	3.10	0.114	0.118	0.122	
E	1.30	1.50	1.70	0.051	0.059	0.067	
е	0.85	0.95	1.05	0.034	0.037	0.041	
L	0.20	0.40	0.60	0.008	0.016	0.024	
HE	2.50	2.75	3.00	0.099	0.108	0.118	
θ	0°	_	10°	0°	_	10°	